

Datasheet

Tiny Dual-Band GNSS Low Power module



LCC-18 (9.7 x 10.1 mm)

Features

- Simultaneous multiconstellation and multi band GNSS (GPS/Galileo/Glonass/ BeiDou/QZSS)
- IRNSS constellation ready
- -162 dBm tracking sensitivity
- · Submeter Positioning Accuracy
- · Embedded Flash
- Firmware upgrade
- · Free firmware configuration
- VCC/VBAT supply voltage range: 3.0 V to 3.63 V
- Tiny LCC-18 pin package (9.7 x 10.1 mm)
- Operating temperature (-40 °C ÷ 85 °C)
- 10 μA standby current consumption and 48.8 mA GNSS L1&L5 tracking current consumption

Description

Teseo-LIV4F module is an easy-to-use Global Navigation Satellite System (GNSS) standalone low power module, embedding Teseo IV single die standalone positioning receiver IC working simultaneously on multiple constellations (GPS/Galileo/Glonass/BeiDou/QZSS).

The Teseo-LIV4F modules bring the proven accuracy and robustness of Teseo IV multi bands chips to the reach of everyone: the embedded firmware and the complete evaluation environment save development time, while the compactness and cost-effectiveness of this solution make it ideal for several applications, such as insurance, goods tracking, drones, tolling, anti-theft systems, people and pet location, vehicle tracking, emergency calls, fleet management, vehicle sharing, diagnostics and public transportation.

Within its 9.7 x 10.1 mm tiny size, Teseo-LIV4F is offering superior accuracy thanks to the on-board Temperature Compensated Crystal Oscillator (TCXO) and a reduced Time To First Fix (TTFF) relying to its dedicated Real Time Clock (RTC) oscillator.

Teseo-LIV4F provides also the Real-Time Assisted GNSS able to predict satellite data based on previous observation of satellite.

Teseo-LIV4F module, being a certified solution, optimizes the time to market of the final applications with a temperature operating range from -40°C to 85°C.

Product status link

Teseo-LIV4F

| Product summary | | | |
|--------------------------------|----------------|--|--|
| Order code Teseo-LIV4F | | | |
| Marking | Teseo-LIV4F | | |
| Temperature range | -40 °C ÷ 85 °C | | |
| Package LCC-18 (9.7 x 10.1 mm) | | | |
| Packing Tape and Reel | | | |



1 Overview

1.1 GNSS performance

Receiver specification:

- GPS/QZSS L1C/A (1575.42 MHz), L5C (1176.45 MHz)
- GLONASS L1OF (1592.9525 ÷ 1610.485 MHz)
- BeiDou B1i (1561.098 MHz), B2a (1207.14 MHz)
- Galileo E1 (1575.42 MHz), E5a (1176.45 MHz)
- SBAS L1C/A

Table 1. GNSS performance

| Parameter | Specification | GNSS | GPS&BD | Unit |
|---|-------------------------|-------|--------|-------|
| | Cold start | 28.5 | 28.5 | |
| Time To First Fix ⁽¹⁾ | Warm start | 20.0 | 21.0 | s |
| | Hot start | 1.5 | 1.44 | |
| Sensitivity ⁽²⁾ | Tracking ⁽³⁾ | -162 | -162 | dBm |
| Sensitivity | Cold start | -148 | -148 | UBIII |
| Max fix rate | - | 10 | 10 | Hz |
| Horizontal position accuracy ⁽⁴⁾ | - | 0.8 | 0.7 | m |
| Accuracy of time pulse | 99% | 20 | | ns |
| Frequency of time pulse | 1 | 1 | 1 | Hz |
| Operational ITAR limits ⁽⁵⁾ | Altitude | 18000 | 18000 | m |
| Operational TTAR IIIIIIIS | Velocity | 515 | 515 | m/s |

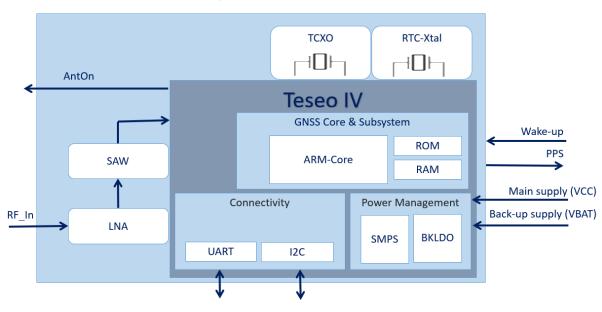
- 1. All satellites at -130 dBm TTFF at 50%
- 2. For BEIDOU tracking sensitivity refers to MEO sats. For GEO the tracking sensitivity is -151 dBm
- 3. With external LNA.
- 4. CEP 50%, 24h static, Roof Antenna.
- To be compliant with USA International Traffic in Arms Regulations (ITAR), when both the ITAR altitude limit and the ITAR velocity limit are overpass taken the Teseo-LIV4F stops providing NMEA stream.

DS13957 - Rev 1 page 2/30



1.2 Block diagram

Figure 1. Module block schematic



1.3 Pin configuration

Figure 2. Module pins layout

| 10 | GND_RF | | nRESET | 9 |
|----|----------|------------|----------|---|
| 11 | RF_IN | | VCC | 8 |
| 12 | GND_RF | | Reserved | 7 |
| 13 | Reserved | Teseo-LIV4 | VBAT | 6 |
| 14 | VCC_RF | | WakeUP | 5 |
| 15 | Reserved | | PPS | 4 |
| 16 | I2C_SDA | | UART-RX | 3 |
| 17 | I2C_SCL | | UART-TX | 2 |
| 18 | PRG | | GND | 1 |
| | | | | |

DS13957 - Rev 1 page 3/30



1.4 Pin out description

Table 2. Module pin out description

| Pin# | Name | I/O | Description | |
|------|----------|--------|---|--|
| 1 | GND | Ground | Ground | |
| 2 | UART-TX | 0 | Serial Port Tx (if not used, must be left floating) | |
| 3 | UART-RX | I | Serial Port Rx | |
| 4 | PPS | 0 | Time pulse (PPS) (if not used, must be left floating) | |
| 5 | WakeUp | I | External Interrupt Pin (if not used, must be left floating) | |
| 6 | VBAT | I | Backup voltage supply | |
| 7 | Reserved | - | Reserved | |
| 8 | VCC | I | Main voltage supply | |
| 9 | nReset | I | nReset (if not used, must be left floating) | |
| 10 | GND_RF | Ground | Ground | |
| 11 | RF_IN | | RF Input signal | |
| "" | KF_IN | I | VCC voltage is available on the pin | |
| 12 | GND_RF | Ground | Ground | |
| 13 | Reserved | - | Reserved | |
| 14 | VCC_RF | 0 | External Antenna Supply (voltage equals to VCC, pin 8) | |
| 15 | Reserved | - | Reserved | |
| 16 | I2C_SDA | I/O | I ² C Data (if not used, must be left floating) | |
| 17 | I2C_SCL | I/O | I ² C Clock (if not used, must be left floating) | |
| 18 | PRG | I | Program or WakeUp from DeepStandby | |

DS13957 - Rev 1 page 4/30



2 Supported GNSS constellation

The embedded firmware supports all the GNSS constellations: GPS, GLONASS, GALILEO, BEIDOU and QZSS (ready for IRNSS). The user can select what the application needs by firmware configuration.

2.1 GPS

The Teseo-LIV4F GNSS module can receive and process the L1C/A and L5C signals provided by the Global Positioning System (GPS).

2.2 GLONASS

The Teseo-LIV4F module can receive and process the GLONASS L1OF signal.

2.3 BeiDou

The Teseo-LIV4F modules can receive and process BeiDou B1I and B2a signals.

2.4 Galileo

The Teseo-LIV4F can receive and process Galileo E1 and E5 signals.

2.5 IRNSS

Prerelease product(s)

The Teseo-LIV4F is ready for IRNSS using a dedicated firmware.

DS13957 - Rev 1 page 5/30



3 Augmentation systems

3.1 Satellite_Based augmentation system

Teseo-LIV4F supports SBAS. SBAS is a Wide Area Differential GPS (WADGPS). It is a system which provides differential GPS corrections data; SBAS includes the WAAS within the United States, the EGNOS within Europe, the Multifunctional Transport Satellite (MTSAT)-based MSAS within Japan and Southeast Asia, and the GPS and GEO Augmented Navigation (GAGAN) system in India.

The SBAS data correction is used in the GNSS algorithm to provide a better position estimation. The overall SBAS differential correction mechanism can be conceived as built in 2 phases:

- The "Acquire and Tracking" phase.
- · The "Decoding" phase.

The "Acquire and Track" phase relates to the capacity of the acquisition engine to reliably track the configured SBAS satellite; during decoding phase the SBAS message can be decoded to fetch the differential corrections.

The current longitude limits for each service are:

- WAAS -180 degrees to -25 degrees
- EGNOS -25 degrees to +50 degrees
- GAGAN +50 degrees to +100 degrees
- MSAS +100 degrees to +180 degrees

The Teseo-LIV4F software with SBAS capability implements a command interface at the NMEA level to allow interaction with the SBAS library. It supports commands to enable/disable the SBAS functionality.

3.2 QZSS

The Quasi-Zenith Satellite System (QZSS) is a Japanese regional communication services and positioning information for the mobile environment in the GPS L1C/A band. QZSS in conjunction with GPS signals provides GNSS augmentation service for the Pacific region covering Japan and Australia. QZSS satellites are placed in a periodic Highly Elliptical Orbit (HEO): these orbits allow the satellites to "dwell" for more than 12 hours a day at an elevation above 70° (it means that they appear almost overhead most of the time).

DS13957 - Rev 1 page 6/30



4 Assisted GNSS

GNSS receivers need accurate satellite position data from at least 4 satellites to produce a fix.

Accurate satellite data, ephemeris data, is valid for several hours based on the active constellations.

After that time, a receiver must download new ephemeris data.

Ephemeris download can take from dozens of seconds to several minutes, hours or can fail to download.

Assisted-GNSS is a mechanism to provide ephemeris assistance from external source; this reduces considerably the time to get fix especially in critical environments when the ephemeris download time could be very long.

Teseo-LIV4F supports one types of Assisted GNSS: Real Time Assisted GNSS.

4.1 Real-Time Assisted GNSS

Real-Time Assisted GNSS (RT-AGNSS) solution is a server based Assisted GNSS. It requires a network connection to download assistance data from the server.

RT-AGNSS works downloading by an assistance server the real time ephemeris data. Server access is allowed thanks to internal keyword provided by Teseo-LIV4F to the Host processor and the acquired real-time data have to be provided to Teseo-LIV4F.

Proprietary NMEA commands are supported on Teseo-LIV4F to acquire the credential access to the external server and to inject the data to Teseo-LIV4F.

STMicroelectronics partner provides available server solution access on Teseo-LIV4F solution.

Real-Time A-GNSS allows continuous real-time satellite position determination.

DS13957 - Rev 1 page 7/30



5 Clock generation

5.1 Temperature-Compensated Crystal Oscillator (TCXO)

Highly stable oscillator controls the down conversion process in RF block of the Teseo-LIV4F. Characteristics of this component are important factors for higher sensitivity to maximize performances especially in weak-signal environments, as well as to minimize the Time To First Fix (TTFF) and better navigation stability.

5.2 Real Time Clock (RTC)

This is an always-on power domain dedicated to RTC logic (backup system) and supplied with a dedicated voltage regulator.

The RTC provides a high-resolution clock. It keeps the time when the system is inactive and it is internally used to wake up the system when in low power mode. It has a clock trimming feature to compensate for the accuracy of the crystal and a secured time update.

DS13957 - Rev 1 page 8/30



6 I/O interfaces

Teseo-LIV4F supports the following I/O interfaces:

- UART port
- I²C port

NMEA protocol is supported on both UART and I²C ports.

6.1 UART

The Universal Asynchronous Receiver/Transmitter (UART) supports much of the functionality of the industry-standard 16C650 UART.

The UART performs serial-to-parallel conversion on data asynchronously received from a peripheral device on UART-RX pin, and parallel-to-serial conversion on data written by CPU for transmission on UART-TX pin. The transmit and receive paths are buffered with internal FIFO memories allowing up to 64 data bytes for transmission, and 64 data bytes with 4-bit status (break, frame, parity, and overrun) for receive.

6.2 I^2C

Teseo-LIV4F includes a slave I²C interface configurable.

Unlike all other interfaces, I²C is not able to communicate in full-duplex mode; it uses only two bidirectional open-drain lines, Serial Data Line on pin I2C_SDA and Serial Clock Line on pin I2C_SCL, pulled up with resistors.

Teseo-LIV4F receiver always acts as slave and it cannot initiate data transmission on the bus; host must periodically poll the receiver to check about data availability.

The main features are:

- Normal speed (100 kHz) and Fast speed (400 kHz) supported.
- I²C-slave address configurable using the firmware configurator.

DS13957 - Rev 1 page 9/30

Prerelease product(s)

7 Antenna voltage supply (VCC_RF, pin 14)

Teseo-LIV4F has built-in LNA and SAW. It is recommended to use an active antenna with gain less than 36 dB and the noise figure less than 1.5 dB.

Teseo-LIV4F has built-in short circuit detection and open circuit detection function, which can detect the status of normal connection, and send out antenna status prompt message in NMEA data:

- Short circuit protection: once an overcurrent is detected at the VCC_RF pin (pin 14), the module will cut off this power supply automatically to prevent permanent damages.
- · Open circuit detection: Teseo-LIV4F can detect an open circuit in the antenna.

Table 3 reports the antenna status threshold.

Table 3. Antenna Status current threshold

| Antenna Status | Status Output | VCC_RF on current range |
|---------------------------------|---------------|------------------------------|
| Open circuit | OPEN | 0 < VCC_RF ≤ 1 mA |
| Regular circuit or open circuit | OK or OPEN | 1 mA < VCC_RF ≤ 2 mA |
| Regular circuit | OK | 2 mA < VCC_RF ≤ 40 mA ± 5 mA |
| Short circuit | SHORT | 40 mA ±5 mA < VCC_RF ≤ 55 mA |

DS13957 - Rev 1 page 10/30

8 Firmware update support

The Teseo-LIV4F receiver module can be updated with new firmware releases. The latest firmware version is available at www.st.com and it can be installed on Teseo-LIV4F using the available PC Tool Teseo-Suite available at www.st.com.

Detailed information is available on Teseo-LIV4F software user manual.

DS13957 - Rev 1 page 11/30

9 Firmware configuration

All configuration parameters are grouped in a data block. Each field is addressed by a unique ID. The IDs are made by three digits: the most significant one represents the parameter type and the others are used to identify different parameters of the same type.

Default setting of configuration data block is hard coded into the binary image file.

A new configuration can be built using the PC Tool Teseo-Suite, available at www.st.com or using runtime configuration commands raised by the host.

DS13957 - Rev 1 page 12/30



Prerelease product(s)

10 Power mode

Standby mode is the mode where only low power backup domain is running. It means VBAT (pin 22) must be always maintained.

It allows to have very low current consumption and fast GNSS reacquisition at the end of the standby time due to RTC.

DS13957 - Rev 1 page 13/30



11 Regulatory compliance

The Teseo-LIV4F module has been certified according to the following standards:

- Radio Equipment Directive (RED) 2014/53/EU
- EN 62368-1:2020+A11:2020
- ETSI EN 301 489-1 V2.2.3 + ETSI EN 301 489-19 V2.2.0
- ETSI EN 303 413 V1.2.1

The module is provided by CE marking:



The Certificate of Conformity is available/downloadable at the following webpage: www.st.com at the Teseo-LIV4F page.

For additional information refer to:

STMicroelectronics Via C. Olivetti, 2 Agrate Brianza (MB) 20864 (ITALY)

The Teseo-LIV4F module current production firmware release is:

\$PSTMVER,GNSSLIB 8.6.x.xx ARM*xx

The manufacturer, STMicroelectronics, declares that the Teseo-LIV4F radio equipment complies with the 2014/53/UE directive.

The full text of the EU declaration of conformity is available at the following Internet address: www.st.com at the Teseo-LIV4F page.

11.1 Approvals

The Teseo-LIV4F module is RoHS and WEEE compliant.



In the countries belonging to the European Union, the Teseo-LIV4F is subject to differentiated recycling at the end of its life cycle.

The Teseo-LIV4F must be disposed as an undifferentiated waste or with other domestic wastes.

The abandonment of this waste in the environment, or in landfills, or in waste-to-energy plants, has as consequence the pollution of soil, air and water, with repercussions on human health.

DS13957 - Rev 1 page 14/30



12 Electrical characteristics

12.1 Parameter conditions

Unless otherwise specified, all voltages are referred to GND.

12.2 Minimum and maximum values

Unless otherwise specified the minimum and maximum values are guaranteed in the worst conditions of ambient temperature, supply voltage and frequencies by tests in production on 100% of the devices with an operating ambient temperature at $T_C = 25$ °C.

12.3 Typical values

Unless otherwise specified, typical data are based on T_C = 25 °C, VCC = 3.3 V and VBAT = 3.3 V.

They are given only as design guidelines and are not tested.

Unless otherwise specified, all typical curves are given only as design guidelines and are not tested.

DS13957 - Rev 1 page 15/30



12.4 Absolute maximum ratings

This product contains devices to protect the inputs against damage due to high static voltages, however it is advisable to take normal precautions to avoid application of any voltage higher than the specified maximum rated voltages.

Table 4. Module supply voltage characteristics

| Symbol | Parameter | Min | Тур | Max | Unit |
|--------|-----------------------------|-----|-----|------|------|
| VCC | Digital supply voltage | 3.0 | 3.3 | 3.63 | V |
| VBAT | Backup input supply voltage | 3.0 | 3.3 | 3.63 | V |

Table 5. Module thermal characteristics

| Symbol | Parameter | Min | Max | Unit |
|-------------------|-----------------------------|-----|-----|------|
| T _{oper} | Operative temperature range | -40 | 85 | °C |
| T _{stor} | Storage temperature range | -40 | 85 | °C |

Table 6. Module current consumption

| Symbol | Parameter | Test condition | Тур | Unit | |
|--------------------|-----------------|---------------------------------------|------|------|----|
| | | GNSS L1 + L5; | | | |
| | Test condition | T _C = 25 °C; | 48.8 | mA | |
| Power consumption | | VCC = VBAT = 3.3 V; | | | |
| . oner concumption | | RTC running @ 32.768 kHz; | | | |
| | SW-STANDBY mode | SW-STANDBY mode $T_C = 25 ^{\circ}C;$ | | 10 | μA |
| | | VCC = VBAT = 3.3V | | | |

DS13957 - Rev 1 page 16/30



12.5 Recommended DC operating conditions

Table 7. Recommended DC operating conditions

| Symbol | Parameter | Min | Тур | Max | Unit |
|--------|---|-----|-----|------|------|
| VCC | Power supply pins | 3.0 | 3.3 | 3.63 | V |
| VBAT | Power supply pins for backup internal logic | 3.0 | 3.3 | 3.63 | V |

Table 8. I/O voltage characteristic for nReset and PRG pins

| Parameter | Condition | Min | Тур | Max | Unit |
|--------------------|-----------|----------|-----|----------|------|
| Input high voltage | - | VBAT*0.7 | - | VBAT | V |
| Input low voltage | - | 0 | - | VBAT*0.3 | V |
| Pull-up resistance | - | 18 | - | 84 | kΩ |

Table 9. I/O voltage characteristic for the other pins

| Parameter | Condition | Min | Тур | Max | Unit |
|---------------------|-------------|---------|-----|---------|------|
| Input high voltage | - | VCC*0.7 | - | VCC | V |
| Input low voltage | - | 0 | - | VCC*0.3 | V |
| Pull-up resistance | - | 35 | - | 84 | kΩ |
| Output high voltage | VCC = 3.3 V | 2.64 | - | | V |
| Output low voltage | VCC = 3.3 V | | - | 0.4 | V |

DS13957 - Rev 1 page 17/30



13 Reflow soldering profile

The Teseo-LIV4F is a high temperature strength surface mount GNSS module supplied on a 18 pin, 6-layer PCB. The final assembly recommended reflow profiles are indicated here below.

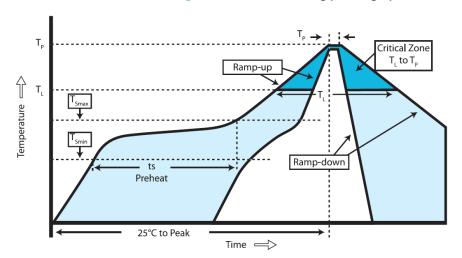
Soldering phase must be executed with care: to avoid undesired melting phenomenon, particular attention has to be taken on the set up of the peak temperature.

Here below some suggestions about the temperature profile based on the following recommendations.

Table 10. Module soldering profile values

| Profile feature | PB-free assembly |
|--|------------------|
| Average ramp-up rate (T _{SMAX} to T _p) | 3 °C/sec max |
| Preheat: | |
| - Temperature min (T _{Smin}) | 150 °C |
| - Temperature max (T _{Smax}) | 200 °C |
| - Time (t _{Smin} to t _{Smax}) (t _S) | 60 ÷ 100 sec |
| Time maintained above: | |
| - Temperature (T _L) | 217° C |
| - Time (t _L) | 60 ÷ 70 sec |
| Peak temperature (T _P) | 245 ± 5 °C |
| Time within 5 °C of actual peak temperature (T _P) | 10 ÷ 20 sec |
| Ramp-down rate | 6 °C/sec |
| Time from 25 °C to peak temperature | 8 minute max. |

Figure 3. Module soldering profile graph



DS13957 - Rev 1 page 18/30



Shipping information 14

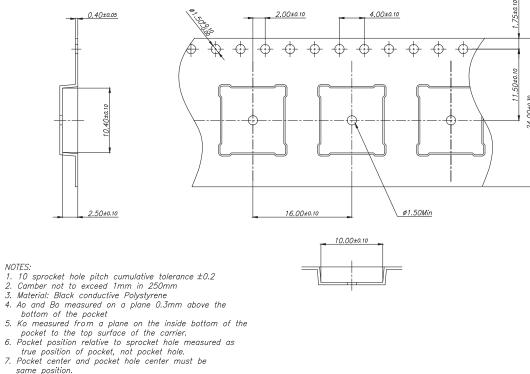
Teseo-LIV4F is delivered as reeled tapes.

To protect it from physical damage, the reels are individually packed in cartons.

14.1 Reels

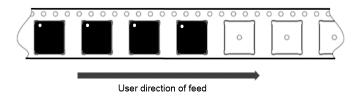
Teseo-LIV4F reel specification is as shown in Figure 4:

Figure 4. Module carrier type specifications



- same position.

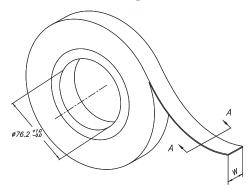
Figure 5. Module orientation specifications



DS13957 - Rev 1 page 19/30



Figure 6. Module cover tape specifications



- 1. MATERIAL : POLYESTER FILM
- 2. COLOR: TRANSPARENT
 3. DESCRIPTION: HEAT ACTIVATED SEAL TAPE
- 4. ALL DIMENSIONS ARE IN MILIMETERS
 5. ESD : 10 ⁵ to 10 ¹¹ ohms/SQ.
 6. CORE MATERIAL : ABS

<Tape Size Information>

| CARRIER TAPE WIDTH | COVER TAPE DIMENSION | | |
|--------------------|----------------------|--------|--|
| | WIDTH | LENGTH | |
| 24 mm | 21.00 ±0.1 | 500M | |

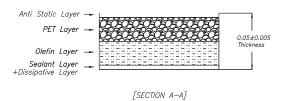
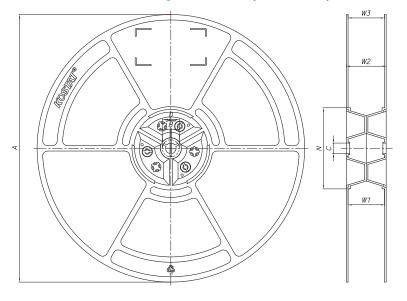
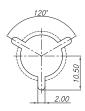


Figure 7. Module plastic reel specifications







DS13957 - Rev 1 page 20/30

MEASURE POINT 1050.00±10.00

Figure 8. Module PB band specifications

| | WIDTH (mm) | 8 | 12 | 16 | 24 | 32 | 44 | 56 |
|----------|------------|------|-------|-------|-------|-------|-------|-------|
| UNIT: mm | G (± 0.10) | 8.20 | 12.20 | 16.20 | 24.20 | 32.20 | 44.20 | 56.20 |

14.2 Packing cartons for reels

To avoid damage each Teseo-LIV4F reel has a dedicated carton box of 340 x 340 x 38 mm.

14.3 **ESD** handling precautions

Teseo-LIV4F module is Electrostatic Sensitive Devices (ESD). Observe precautions for handling! Failure to observe these precautions can result in severe damage to the GNSS receiver.

GNSS receivers are Electrostatic Sensitive Devices (ESD) and require special precautions when handling. Care must be exercised when handling patch antennas, due to the risk of electrostatic charges.

14.4 Moisture sensitivity levels

The Moisture Sensitivity Level (MSL) relates to the packaging and handling precautions required. Teseo-LIV4F modules are rated at MSL level 3 (three).

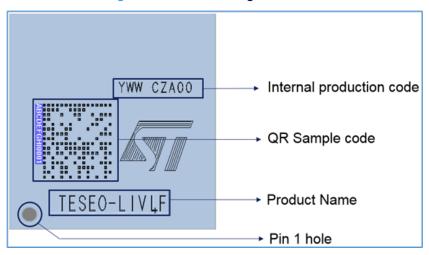
DS13957 - Rev 1 page 21/30



15 Labelling information

The labelling of Teseo-LIV4F reports product information. Information layout of the product is shown in Figure 9:

Figure 9. Module labelling information



Information descriptions are reported in the following table:

Table 11. Module labelling information description

| Items | Description |
|--------------------------|--|
| Internal production code | Production date (YWW: years-week), lot identifier. |
| QR Sample code | QR Sample code used for traceability information of any parts. |
| Product Name | Official product name for Ordering Code. |
| Pin 1 hole | Hole on the shield to identify Pin 1. |

DS13957 - Rev 1 page 22/30

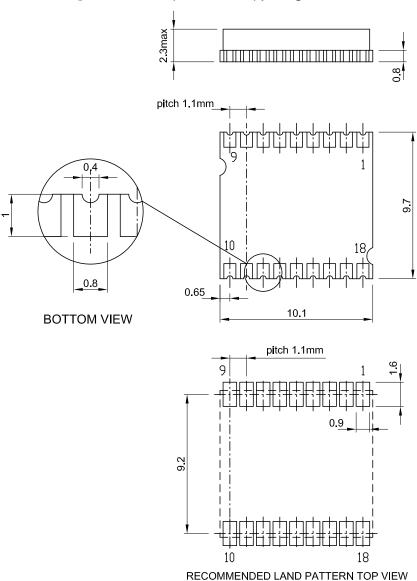


16 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

16.1 LCC-18 (9.7 x 10.1 mm) package information

Figure 10. LCC-18 (9.7 x 10.1 mm) package outline



DS13957 - Rev 1 page 23/30



Table 12. LCC-18 (9.7 x 10.1 mm) package specifications tolerance

| Linear N | leasures | Angle Measures | | |
|------------|-----------|----------------|--------|--|
| No decimal | ±1 mm | No decimal | ±0.10° | |
| .X | ±0.2 mm | .X | ±0.30° | |
| .XX | ±0.1 mm | - | - | |
| .XXX | ±0.05 mm | - | - | |
| .XXXX | ±0.025 mm | - | - | |

DS13957 - Rev 1 page 24/30



Revision history

Table 13. Document revision history

| Date | Version | Changes |
|-------------|---------|------------------|
| 04-Apr-2022 | 1 | Initial release. |

DS13957 - Rev 1 page 25/30



Contents

| 1 | Over | view | 2 | |
|----|--------|---|----|--|
| | 1.1 | GNSS performance | 2 | |
| | 1.2 | Block diagram | 3 | |
| | 1.3 | Pin configuration | 3 | |
| | 1.4 | Pin out description | 4 | |
| 2 | Supp | oorted GNSS constellation | 5 | |
| | 2.1 | GPS | 5 | |
| | 2.2 | GLONASS | 5 | |
| | 2.3 | BeiDou | 5 | |
| | 2.4 | Galileo | 5 | |
| | 2.5 | IRNSS | 5 | |
| 3 | Augr | nentation systems | 6 | |
| | 3.1 | Satellite_Based augmentation system | 6 | |
| | 3.2 | QZSS | 6 | |
| 4 | Assi | sted GNSS | 7 | |
| | 4.1 | Real-Time Assisted GNSS | 7 | |
| 5 | Cloc | k generation | 8 | |
| | 5.1 | Temperature-Compensated Crystal Oscillator (TCXO) | 8 | |
| | 5.2 | Real Time Clock (RTC) | 8 | |
| 6 | I/O ir | I/O interfaces | | |
| | 6.1 | UART | 9 | |
| | 6.2 | I ² C | 9 | |
| 7 | Ante | nna voltage supply (VCC_RF, pin 14) | 10 | |
| 8 | Firm | ware update support | 11 | |
| 9 | Firm | ware configuration | 12 | |
| 10 | Powe | er mode | 13 | |
| 11 | Regu | ılatory compliance | 14 | |
| | 11.1 | Approvals | | |
| 12 | Floct | rical characteristics | 15 | |



| | 12.1 | Parameter conditions | 15 | | |
|-----|----------------------|--|----|--|--|
| | 12.2 | Minimum and maximum values | 15 | | |
| | 12.3 | Typical values | 15 | | |
| | 12.4 | Absolute maximum ratings | 16 | | |
| | 12.5 | Recommended DC operating conditions | 17 | | |
| 13 | Reflo | ow soldering profile | 18 | | |
| 14 | Shipping information | | | | |
| | 14.1 | Reels | 19 | | |
| | 14.2 | Packing cartons for reels | 21 | | |
| | 14.3 | ESD handling precautions | 21 | | |
| | 14.4 | Moisture sensitivity levels | 21 | | |
| 15 | Labe | Iling information | 22 | | |
| 16 | Pack | age information | 23 | | |
| | 16.1 | LCC-18 (9.7 x 10.1 mm) package information | 23 | | |
| Rov | ision l | history | 25 | | |



List of tables

| Table 1. | GNSS performance | . 2 |
|-----------|---|-----|
| Table 2. | Module pin out description | . 4 |
| Table 3. | Antenna Status current threshold | 10 |
| Table 4. | Module supply voltage characteristics | 16 |
| Table 5. | Module thermal characteristics | 16 |
| Table 6. | Module current consumption | 16 |
| Table 7. | Recommended DC operating conditions | 17 |
| Table 8. | I/O voltage characteristic for nReset and PRG pins | 17 |
| Table 9. | I/O voltage characteristic for the other pins | 17 |
| Table 10. | Module soldering profile values | 18 |
| Table 11. | Module labelling information description | 22 |
| Table 12. | LCC-18 (9.7 x 10.1 mm) package specifications tolerance | 24 |
| Table 13. | Document revision history | 25 |



List of figures

| Figure 1. | Module block schematic | . 3 |
|------------|--|-----|
| Figure 2. | Module pins layout | . 3 |
| Figure 3. | Module soldering profile graph | 18 |
| Figure 4. | Module carrier type specifications | 19 |
| Figure 5. | Module orientation specifications | 19 |
| Figure 6. | Module cover tape specifications | 20 |
| Figure 7. | Module plastic reel specifications | 20 |
| Figure 8. | Module PB band specifications | 21 |
| Figure 9. | Module labelling information | 22 |
| Figure 10. | LCC-18 (9.7 x 10.1 mm) package outline | 23 |
| | | |



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DS13957 - Rev 1 page 30/30